E-System Design, Inc. 51/PI integrity solutions for any dimension!

3D-IC's - Real or Imaginary: BOTH! And what would speed adoption?





NOT Photo shopped : So why Both?

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SI/PI integrity solutions for any dimension

Perfect analogy is a complex number: a + bi

Used to describe many complex situations where solution has 'real' and 'imaginary' units:

- Engineering
- Electromagnetism
- Quantum physics
- Applied mathematics
- Chaos Theory

Control systems analysis determine values of K that have Stable vs Unstable operating regions



2.5/3D EcoSystem



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Accelerate adoption?



How to enable ALL? \rightarrow (Product & Test Eng)

- Improve learning across the ecosystem to drive:
 - > Tools to help reduce risk/raise yields (planning, design and verification)
 - > Tools to help improve post silicon analysis
 - > Cheaper fabrication
 - > Cheaper materials
 - > Shorter mfg time
 - > Publish success stories

Sphinx 3D EXT Tool (SI/PI planning and analysis)

High Density

• 1000s of WB, TSV Density 10⁶/cm²....

Inhomogeneous surrounding

- molding, Silicon ...
- Direct influence on transistor performance due to proximity
- Carries high frequency signals
- Parasitics dictate chip performance
- □ Fast for 'what if' or planning purposes

Output:

- Touchstone Output File
- Supports Current Distribution Plotting
- Supports graphical viewing of input file
- Supports spice netlist generation

Additional information under NDA



Energy Lost

Courtesy: Dr. Ivan Ndip, IZM, Germany

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10⁹ Hz





All conductors are uniformly excited.

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At low Hz, all inductances are mainly functions of distance between lines.At high Hz, inductances decrease according different proximity effects.





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